

IDS - 11/10/2005

**ELECTRONIC INFORMATION DISCLOSURE STATEMENT**

Electronic Version v18

Stylesheet Version v18.0

**Title of  
Invention**Elimination of RDL Using Tape Base Flip Chip on Flex for Die  
Stacking

Application Number : 10/050507  
Confirmation Number: 7687  
First Named Applicant: Teck Lee  
Attorney Docket Number: MTI-31607  
Art Unit: 2813  
Examiner: Jack SJ Chen  
Search string: ( 6308525 or 5468995 or 6610559 ).pn

**US Patent Documents****Note: Applicant is not required to submit a paper copy of cited US Patent Documents**

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
DAZ	1	6308525	2001-03-27	Imasu et al.		361	783
DAZ	2	5468995	1995-11-21	Higgins III		257	697
DAZ	3	6610559	2003-08-26	Wang et al.		438	108


**Signature**

Examiner Name	Date
/David Zarneke/	05/22/2006

**IDS - 01/03/2006 ELECTRONIC INFORMATION DISCLOSURE STATEMENT**

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Stylesheet Version v18.0

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<p>Application Number : 10/050507 </p> <p>Confirmation Number: 7687</p> <p>First Named Applicant: Teck Lee</p> <p>Attorney Docket Number: MTI-31607</p> <p>Art Unit: 2813</p> <p>Examiner: Jack SJ Chen</p> <p>Search string: ( 6624060 or 20020027080 or 20030134450 ).pn</p>							
<b>US Patent Documents</b>							
<b>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</b>							
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
DAZ	1	6624060	2003-09-23	Chen et al.		438	613
<b>US Published Applications</b>							
<b>Note: Applicant is not required to submit a paper copy of cited US Published Applications</b>							
init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
DAZ	1	20020027080	2002-03-07	Yoshioka et al.	A1	205	123
DAZ	2	20030134450	2003-07-17	Lee	A1	438	106
<b>Signature</b>							
Examiner Name				Date			
/David Zarneke/				05/22/2006			

PTO/SB/08a (08-03)

Approved for use through 07/31/2006. OMB 0851-0031

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<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> (Not for submission under 37 CFR 1.99)	Application Number	10050507
	Filing Date	2002-01-16
	First Named Inventor	Teck Kheng Lee
	Art Unit	2891
	Examiner Name	David A. Zameke
Attorney Docket Number		MTI-31607

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DAZ	1	5768109		1998-06-16	Gulick et al.	
	2	6285081	B1	2001-09-04	Jackson	
	3	6037665		2000-03-14	Miyazaki	
	4	6791195	B2	2004-09-14	Urushima	
	5	6373268	B1	2002-04-16	Dunlap et al.	
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	1	20020127769	A1	2002-09-12	Ma et al.	
DAZ	2	20030012930	A1	2003-01-16	Brousseau, III	

/David Zameke/

05/19/2006

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Examiner Name	David A. Zarneke
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**FOREIGN PATENT DOCUMENTS**

Examiner Initial*	Cite No	Foreign Document Number <sup>3</sup>	Country Code <sup>2</sup>	Kind Code <sup>4</sup>	Publication Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear	T <sup>5</sup>
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init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
DAZ	1	4415403	1983-11-15	Bakewell		216	27
DAZ	2	6847105	2005-01-25	Koopmans		257	686
 <b>Signature</b>							
Examiner Name				Date			
/David Zarneke/				05/22/2006			